

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







TEA1611T

Zero voltage switching resonant converter controller

Rev. 01 — 7 September 2009

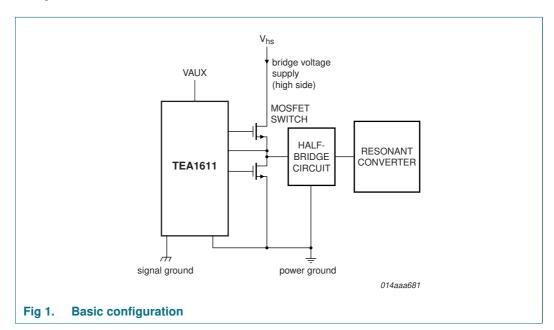
Product data sheet

1. General description

The TEA1611T is a monolithic integrated circuit implemented in a high voltage Diffusion Metal Oxide Semiconductor (DMOS) process, which is a high voltage controller for a zero voltage switching resonant converter. The IC provides the drive function for two discrete power MOSFETs in a half-bridge configuration. It also includes a level-shift circuit, an oscillator with accurately programmable frequency range, a latched shut-down function and a transconductance error amplifier.

To guarantee an accurate 50 % switching duty factor, the oscillator signal passes through a divide-by-two flip-flop before being fed to the output drivers.

The circuit is very flexible and enables a broad range of applications for different mains voltages.



2. Features

- Integrated high voltage level-shift function
- Integrated high voltage bootstrap diode
- Low start-up current (green function)
- Adjustable non-overlap time
- Internal OverTemperature Protection (OTP)
- OverCurrent Protection (OCP) that activates a shut-down timer



Zero voltage switching resonant converter controller

- Soft start timing pin
- Transconductance error amplifier for ultra high-ohmic regulation feedback
- Latched shut-down circuit for OverVoltage Protection (OVP)
- Adjustable minimum and maximum frequencies
- UnderVoltage LockOut (UVLO)
- Fault latch reset input
- Wide (max 20 V) supply voltage range

3. Applications

- TV and monitor power supplies
- High voltage power supplies

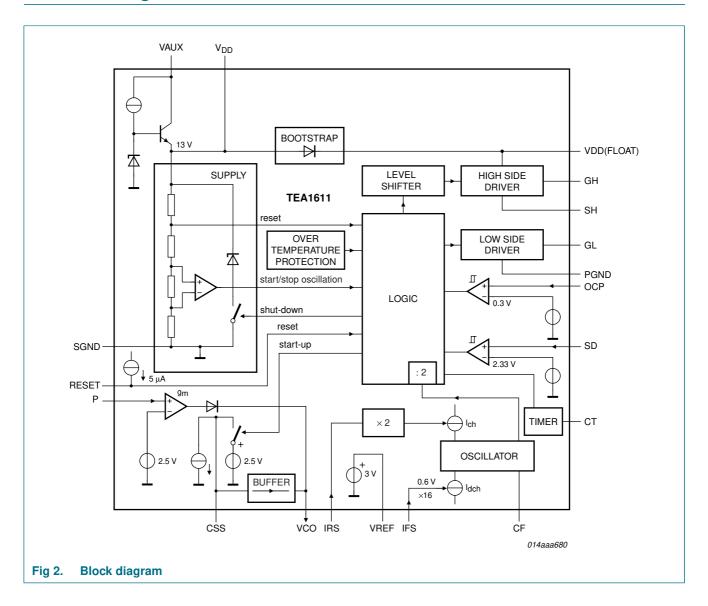
4. Ordering information

Table 1. Ordering information

Type number	Package						
	Name	Description	Version				
TEA1611T	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1				

Zero voltage switching resonant converter controller

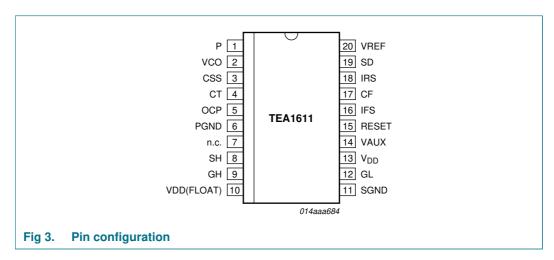
5. Block diagram



Zero voltage switching resonant converter controller

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Р	1	error amplifier non-inverting input
VCO	2	error amplifier output
CSS	3	soft start capacitor input
CT	4	timer capacitor input
OCP	5	overcurrent protection input
PGND	6	power ground
n.c.	7	not connected[1]
SH	8	high side switch source connection
GH	9	high side switch gate connection
VDD(FLOAT)	10	floating supply high side driver
SGND	11	signal ground
GL	12	low side switch gate connection
V_{DD}	13	supply voltage
VAUX	14	auxiliary supply voltage
RESET	15	latch reset input
IFS	16	oscillator discharge current input
CF	17	oscillator capacitor
IRS	18	oscillator charge input current
SD	19	shut-down input
VREF	20	reference voltage

^[1] Provided as a high voltage spacer

Zero voltage switching resonant converter controller

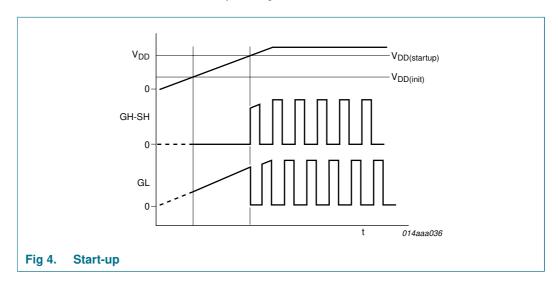
7. Functional description

7.1 Start-up

When the applied voltage at V_{DD} reaches $V_{DD(init)}$ (see <u>Figure 4</u>), the low side power switch is turned on while the high side power switch remains in the non-conducting state. This start-up output state guarantees the initial charging of the bootstrap capacitor (C_{boot}) used for the floating supply of the high side driver.

During start-up, the voltage on the frequency capacitor pin (CF) is zero and defines the start-up state. The voltage at the soft start pin (CSS) is set to 2.5 V. The CSS pin voltage is copied to the VCO pin via a buffer and switching starts at about 80 % of the maximum frequency at the moment V_{DD} reaches the start level.

The start-up state is maintained until V_{DD} reaches the start level (13.5 V), the oscillator is activated and the converter starts operating.

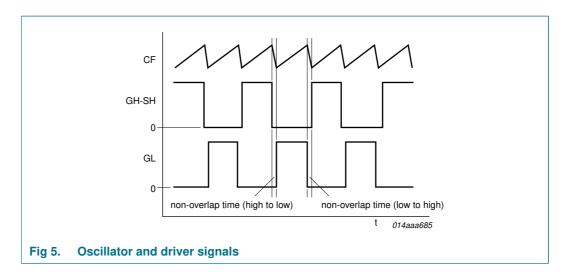


7.2 Oscillator

The internal oscillator is a current-controlled sawtooth oscillator. The frequency of the sawtooth is determined by the external capacitor C_f and the currents flowing into the IFS and IRS pins.

The minimum frequency and the non-overlap time are set by the capacitor C_f and the resistors $R_{f(min)}$ and R_{no} . The maximum frequency is set by resistor $R_{\Delta f}$ (see <u>Figure 7</u>). The oscillator frequency is exactly twice the bridge frequency to achieve an accurate 50 % duty factor. An overview of the oscillator and driver signals is given in <u>Figure 5</u>.

Zero voltage switching resonant converter controller



7.3 Non-overlap time resistor

The non-overlap time resistor R_{no} is connected between the 3 V reference pin (VREF) and the IFS current input pin (see Figure 7). The voltage on the IFS pin is kept at a temperature-independent value of 0.6 V. The current that flows into the IFS pin is determined by the value of resistor's R_{no} 2.4 V voltage drop divided by its value. The IFS input current equals 1/16 of the discharge current of capacitor C_f and determines the falling slope of the oscillator.

The falling slope time is used to create a non-overlap time (t_{no}) between two successive switching actions of the half-bridge switches:

$$I_{IFS} = \frac{2.4V}{R_{no}}$$

$$t_{no} = \frac{C_f \times \Delta V_{Cf}}{16 \times I_{IFS}}$$

7.4 Minimum frequency resistor

The $R_{f(min)}$ resistor is connected between the VREF pin (3 V reference voltage) and the IRS current input (kept at a temperature-independent voltage level of 0.6 V). The charge current of the capacitor C_f is twice the current flowing into the IRS pin.

The $R_{f(min)}$ resistor has a voltage drop of 2.4 V and its resistance defines the minimum charge current (rising slope) of the C_f capacitor if the control current is zero. The minimum frequency is defined by this minimum charge current (I_{IRS1}) and the discharge current:

$$I_{IRS1} = \frac{2.4V}{R_{f(min)}}$$

$$t_{IRSI} = \frac{C_f \times \Delta V_{Cf}}{2 \times I_{IRSI}}$$

Zero voltage switching resonant converter controller

$$f_{osc(min))} = \frac{1}{t_{no} \times t_{IRS1}}$$

$$f_{bridge(min)} = \frac{f_{osc(min)}}{2}$$

7.5 Maximum frequency resistor

The output voltage is regulated by changing the frequency of the half-bridge converter. The maximum frequency is determined by the $R_{\Delta f}$ resistor which is connected between the error amplifier output VCO and the oscillator current input pin IRS. The current that flows through the $R_{\Delta f}$ resistor (I_{IRS2}) is added to the current flowing through the $R_{f(min)}$ resistor. As a result, the charge current ICF increases and the oscillation frequency increases. As the falling slope of the oscillator is constant, the relationship between the output frequency and the charge current is not a linear function (see Figure 6 and Figure 7):

$$I_{IRS2} = \frac{V_{VCO} - 0.6}{R_{\Delta f}}$$

$$t_{IRS2} = \frac{C_f \times \Delta V_{Cf}}{2 \times (I_{IRS1} + I_{IRS2})}$$

The maximum output voltage of the error amplifier and the value of $R_{\Delta f}$ determine the maximum frequency:

$$I_{IRS2(max)} = \frac{V_{VCO(max)} - 0.6}{R_{\Lambda f}}$$

$$t_{IRS(min)} = \frac{C_f \times \Delta V_{Cf}}{2 \times (I_{IRS2} + I_{IRS2(max)})}$$

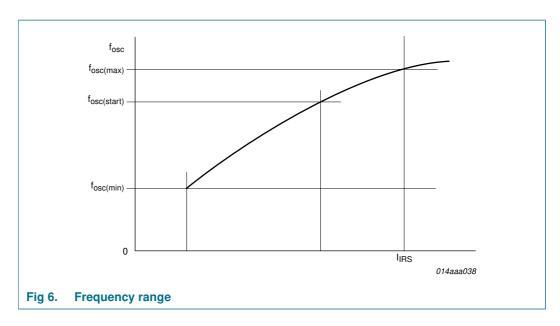
$$f_{osc(max)} = \frac{1}{T_{OSC}}$$

$$f_{bridge(max)} = \frac{f_{osc(max)}}{2}$$

$$T_{OSC} \, = \, t_{IRS(min)} + t_{no}$$

The frequency of the oscillator depends on the value of capacitor C_f , the peak-to-peak voltage swing V_{CF} and the charge and discharge currents. The accuracy of the oscillator frequency decreases at higher frequencies due to delays in the circuit.

Zero voltage switching resonant converter controller



7.6 Error amplifier

The error amplifier is a transconductance amplifier. The output current at pin VCO is determined by the amplifier transconductance, the differential voltage between input pin P, and the internal 2.5 V reference voltage. The output current I_{VCO} is fed to the IRS input of the current-controlled oscillator.

The source capability of the error amplifier increases current in the IRS pin with a positive differential input voltage. Therefore the minimum current is determined by resistor $R_{f(min)}$ and the minimum frequency setting is independent of the characteristics of the error amplifier.

The error amplifier has a maximum output current of 0.5 mA for an output voltage of up to 2.5 V. If the source current decreases, the oscillator frequency also decreases resulting in a higher regulated output voltage.

During start-up, the output voltage of the amplifier is connected to the soft start (CSS) pin via a buffer. This will hold the VCO pin at a constant value of 2.5 V.

7.7 Soft start

The CSS pin voltage is copied to the VCO pin via a buffer. This buffer only has a source capability, i.e. it can only charge the VCO pin. This means that the error amplifier output can increase the VCO pin voltage above the CSS voltage level.

At start-up the soft start capacitor is charged to 2.5 V setting a start-up frequency of about 80 % of the maximum frequency. After start-up the external soft start capacitor is discharged by $I_{\text{start}(soft)}$. The VCO pin voltage will follow the CSS voltage (discharging takes place via $R_{\Delta f}$) and the frequency sweeps down. The CSS capacitor will determine the frequency sweep rate. When the circuit comes into regulation, the error amplifier output will control the VCO pin voltage and the CSS voltage will sweep down further to zero volt.

Zero voltage switching resonant converter controller

7.8 Overcurrent protection and timer

The OCP input continuously compares the OCP pin voltage with VREF. When the OCP pin voltage is higher than VREF, the timer capacitor CT will be charged with I_{ch} during the next full CF cycle. Else the timer capacitor will be discharged with I_{leak} .

In case the CT voltage exceeds $V_{trip(H)}$, the TEA1611T will switch over to shut-down mode. The timer capacitor will be discharged with I_{dch} until the CT voltage reaches $V_{trip(L)}$ after which a soft start cycle is started.

7.9 Shut-down

The shut-down input (SD) has an accurate threshold level of 2.33 V. When the voltage on input SD reaches 2.33 V, the TEA1611T enters shut-down mode.

During shut-down mode, pin V_{DD} is clamped by an internal 12 V Zener diode with a 1 mA input current. This clamp prevents V_{DD} rising above the rating of 14 V due to low supply current to the TEA1611T in shut-down mode.

When the TEA1611T is in the shut-down mode, it can be activated again only by lowering V_{DD} below the $V_{DD(rst)}$ level (typically 5.3 V) or by making the reset input active. The shut-down latch is then reset and a new start-up cycle can begin.

In shut-down mode the GL pin is HIGH and the GH pin is LOW. In this way the bootstrap capacitor remains charged, allowing a new, well defined cycle to start after a reset.

7.10 OverTemperature Protection (OTP)

The TEA1611T continuously monitors its temperature. When the temperature exceeds the $T_{\text{otp(act)}}$ level, the TEA1611T will switch to shut-down mode.

7.11 Latch reset input

The internal shut-down latch can be reset via the reset input. This input is active LOW.

7.12 VAUX input

When the IC is oscillating the start-up resistor is not able to deliver the supply current so that an auxiliary supply (for instance via an auxiliary winding or a dV/dt supply) is needed. The VAUX input facilitates a series regulator which regulates its output voltage (= V_{DD} voltage) to $V_{DD(reg)}$.

8. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Supply vo	Itages					
V _{drv(hs)}	high-side driver voltage			0	600	V
V_{DD}	supply voltage		<u>[1]</u>	0	14	V
V _{CC(AUX)}	auxiliary supply voltage		<u>[1]</u>	0	20	V

TEA1611T_1 © NXP B.V. 2009. All rights reserved.

Zero voltage switching resonant converter controller

Table 3. Limiting values ...continued In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Voltage on	pins P, SD, RESET and OC					
VI	input voltage			0	5	V
Currents						
I _{IFS}	current on pin IFS			-	1/16	mA
I _{IRS}	current on pin IRS			-	1	mA
I _{VREF}	current on pin VREF			-	-2	mA
Power and	temperature					
P _{tot}	total power dissipation	T _{amb} < 70 °C		-	8.0	W
T _{amb}	ambient temperature	operating		-25	+70	°C
T _{stg}	storage temperature			-25	+150	°C
Handling						
V _{ESD}	electrostatic discharge voltage	Human body model	[2]	-	2000	V
		Machine model	[3]	-	200	V

^[1] It is recommended that a buffer capacitor is placed as close as possible to the VDD pin (as indicated in Figure 7 and in the application note).

9. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	100	K/W

10. Characteristics

Table 5. Characteristics

All voltages are referred to the ground pins which must be connected externally; positive currents flow into the IC; $V_{DD} = 13 \text{ V}$ and $T_{amb} = 25 \,^{\circ}\text{C}$; tested using the circuit shown in Figure 7, unless otherwise specified.

Q			•			
Symbol	Parameter	Parameter Conditions Min		Тур	Max	Unit
High voltage	ge pins VDD(FLOAT), GH and S	SH .				
I _{leak}	leakage current	$V_{DD(F)}, V_{GH}$ and $V_{SH} = 600 \text{ V}$	-	-	30	μΑ
Supply pin	is V _{DD} , VAUX					
$V_{\text{DD(init)}}$	initial supply voltage	defined driver output; low side on; high side off	-	4	5	V
V _{DD(startup)}	start-up supply voltage		12.9	13.4	13.9	V
$V_{DD(stop)}$	stop supply voltage		9.0	9.4	9.8	V
$V_{\text{DD(hys)}}$	hysteresis of supply voltage		3.8	4.0	4.2	V

TEA1611T_1 © NXP B.V. 2009. All rights reserved.

^[2] Human body model class 2: equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.

^[3] Machine model class 2: equivalent to discharging a 200 pF capacitor through a 0.75 mH coil and 10 Ω resistor.

Zero voltage switching resonant converter controller

Table 5. Characteristics ...continued

All voltages are referred to the ground pins which must be connected externally; positive currents flow into the IC; $V_{DD} = 13 \text{ V}$ and $T_{amb} = 25 \,^{\circ}\text{C}$; tested using the circuit shown in Figure 7, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DD(reg)}$	regulation supply voltage	VAUX = 17 V	-	12.6	-	V
V_{DD}	supply voltage	current capability series regulator; $V_{CC(AUX)} = 17 \text{ V};$ $I_{DD} = 50 \text{ mA}$	-	12	-	V
		clamp voltage in shut-down state; low side on; high side off; I _{DD} = 1 mA	11.0	12.0	13.0	V
V _{rst}	reset voltage		4.5	5.3	6.0	V
I _{DD}	supply current		[1]			
		start-up	210	260	310	μΑ
		operating	-	2.4	-	mA
		shut-down	-	220	270	μΑ
Reference	voltage on pin VREF					
V_{ref}	reference voltage	$I_{ref} = 0 \text{ mA}$	2.9	3.0	3.1	V
I _{ref}	reference current	source only	-2.0	-	-	mA
Zo	output impedance	$I_{ref} = -1 \text{ mA}$	-	5.0	-	Ω
TC	temperature coefficient	$I_{ref} = 0 \text{ mA};$ $T_j = 25 ^{\circ}\text{C to } 150 ^{\circ}\text{C}$	-	-0.3	-	mV/K
Current co	introlled oscillator pins IRS, IFS,	CF				
I _{ch(CF)min}	minimum charge current on pin CF	$I_{IRS} = 15 \mu A; V_{CF} = 2 V$	28	30	32	μΑ
I _{ch(CF)max}	maximum charge current on pin CF	$I_{IRS} = 200 \ \mu A; \ V_{CF} = 2 \ V$	340	380	420	μΑ
V_{IRS}	voltage on pin IRS	$I_{IRS} = 200 \mu A$	590	620	650	mV
I _{dch(CF)min}	minimum discharge current on pin CF	$I_{IFS} = 50/16 \mu A;$ $V_{CF} = 2 V$	47	50	53	μΑ
I _{dch(CF)max}	maximum discharge current on pin CF	$I_{IFS} = 1/16 \ \mu A; \ V_{CF} = 2 \ V$	0.89	0.94	0.99	mA
V_{IFS}	voltage on pin IFS	$I_{IFS} = 1/16 \text{ mA}$	570	600	630	mV
f _{bridge(min)}	minimum bridge frequency	C_f = 100 pF; I_{IFS} = 0.5/16 mA; I_{IRS} = 50 μ A; f_{bridge} = $\frac{f_{OSC}}{2}$	156	167	178	kHz
f _{bridge(max)}	maximum bridge frequency	$C_f = 100 \text{ pF};$ $I_{IFS} = 1/16 \text{ mA};$ $I_{IRS} = 200 \mu\text{A};$ $f_{bridge} = \frac{f_{OSC}}{2}$	2 395	440	485	kHz
$V_{trip(L)}$	LOW-level trip voltage	pin CF; DC level	-	1.27	-	V
$V_{trip(H)}$	HIGH-level trip voltage	pin CF; DC level	-	2.97	-	V
TEA1611T_1					© NXP B.V. 200	9. All rights reserved

Zero voltage switching resonant converter controller

 Table 5.
 Characteristics ... continued

All voltages are referred to the ground pins which must be connected externally; positive currents flow into the IC; $V_{DD} = 13 \text{ V}$ and $T_{amb} = 25 \text{ °C}$; tested using the circuit shown in Figure 7, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CF(p-p)}$	peak-to-peak voltage on pin CF	DC level	1.6	1.7	1.8	V
t _{no}	non-overlap time	$C_f = 100 \text{ pF};$ $I_{IFS} = 0.5/16 \text{ mA};$ $I_{IRS} = 50 \mu\text{A}$	0.58	0.63	0.68	μs
I _{dch(osc)} /I _{IFS}	oscillator discharge current to current on pin IFS ratio	$I_{IFS} = 0.5/16 \text{ mA};$	14.4	16	17.6	
Output dri	vers					
I _{source(GH)}	source current on pin GH	high side; $V_{DD(F)} = 11.2 \text{ V};$ $V_{SH} = 0 \text{ V};$ $V_{GH} = 0 \text{ V}$	-	300	-	mA
I _{sink(GH)}	sink current on pin GH	high side; $V_{DD(F)} = 11.2 \text{ V};$ $V_{SH} = 0 \text{ V}; V_{GH} = 11.2 \text{ V}$	-	480	-	mA
I _{source(GL)}	source current on pin GL	low side; $V_{GL} = 0 V$	-	300	-	mA
I _{sink(GL)}	sink current on pin GL	low side; $V_{GL} = 13 \text{ V}$	-	580	-	mA
V _{OH}	HIGH-level output voltage	pin GH; high side; $V_{DD(F)} = 11.2 \text{ V};$ $V_{SH} = 0 \text{ V}; I_{GH} = 10 \text{ mA}$	-	10.9	-	V
		pin GL; low side; I _{GL} = 10 mA	-	12.6	-	V
V _{OL}	LOW-level output voltage	pin GL; high side; $V_{DD(F)} = 11.2 \text{ V};$ $V_{SH} = 0 \text{ V}; I_{GH} = 10 \text{ mA}$	-	0.17	-	V
		pin GL; low side; I _{GL} = 10 mA	-	0.18	-	V
V _{Fd(bs)}	bootstrap diode forward voltage	$I_O = 5 \text{ mA}$	1.3	1.6	1.9	V
Shut-down	n input pin SD					
I _I	input current	$V_{SD} = 2.33 \text{ V}$	-	-	0.5	μΑ
$V_{th(SD)}$	threshold voltage on pin SD		2.26	2.33	2.40	V
Error ampl	lifier pins P, VCO					
I _{I(cm)}	common-mode input current	$V_{I(CM)} = 1 V$	-	-0.1	-0.5	μΑ
V _{I(cm)}	common-mode input voltage		-	-	2.5	V
$V_{I(offset)}$	offset input voltage	$V_{I(CM)} = 1 V;$ $I_{VCO} = -10 \text{ mA}$	-2	0	+2	mV
g _m	transconductance	$V_{I(CM)} = 1 V$; source only	-	330	-	μ A /mV
G _{ol}	open-loop gain	$\begin{aligned} R_L &= 10 \text{ k}\Omega \text{ to GND;} \\ V_{I(CM)} &= 1 \text{ V} \end{aligned}$	-	70	-	dB
GB	gain bandwidth product	$R_L = 10 \text{ k}\Omega \text{ to GND};$ $V_{I(CM)} = 1 \text{ V}$	-	5	-	MHz
$V_{VCO(max)}$	maximum VCO voltage	operating; R_L = 10 k Ω to GND	3.2	3.6	4.0	V
$I_{VCO(max)}$	maximum VCO current	operating; $V_{VCO} = 1 V$	-0.4	-0.5	-0.6	mA
V _O	output voltage	during start-up; I _{VCO} = 0.3 mA	2.5	2.7	2.9	V

Zero voltage switching resonant converter controller

 Table 5.
 Characteristics ...continued

All voltages are referred to the ground pins which must be connected externally; positive currents flow into the IC; $V_{DD} = 13 \text{ V}$ and $T_{amb} = 25 \text{ °C}$; tested using the circuit shown in Figure 7, unless otherwise specified.

	<u> </u>		· · · · · · · · · · · · · · · · · · ·			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Reset pin						
V_{rst}	reset voltage		2.15	2.4	2.65	V
$V_{rst(hys)}$	hysteresis of reset voltage		-	0.65	-	V
I _{I(rst)}	reset input current		-	-	1	μΑ
CSS pin						
I _{start(soft)}	soft start current		12	15	18	μΑ
CT pin						
I _{ch}	charge current		21	27	33	μΑ
I _{dch}	discharge current		8	10	12	μΑ
I _{leak}	leakage current		0.1	0.3	1	μΑ
I_{ch}/I_{dch}	charge current to discharge current ratio		2.4	2.7	3.0	μΑ
$V_{trip(H)}$	HIGH-level trip voltage		2.7	3	3.3	V
$V_{trip(L)}$	LOW-level trip voltage		0.6	0.7	8.0	V
OCP pin						
V_{ref}	reference voltage		280	305	330	mV
ОТР						
T _{otp(act)}	activation overtemperature protection temperature		120	135	150	°C

^[1] The supply current I_{DD} increases with an increasing bridge frequency to drive the capacitive load of two MOSFETs. Typical MOSFETs for the TEA1611T application are 8N50 (NXP type PHX80N50E, Q_{G(tot)} = 55 nC typ.) and these will increase the supply current at 150 kHz according to the following formula:

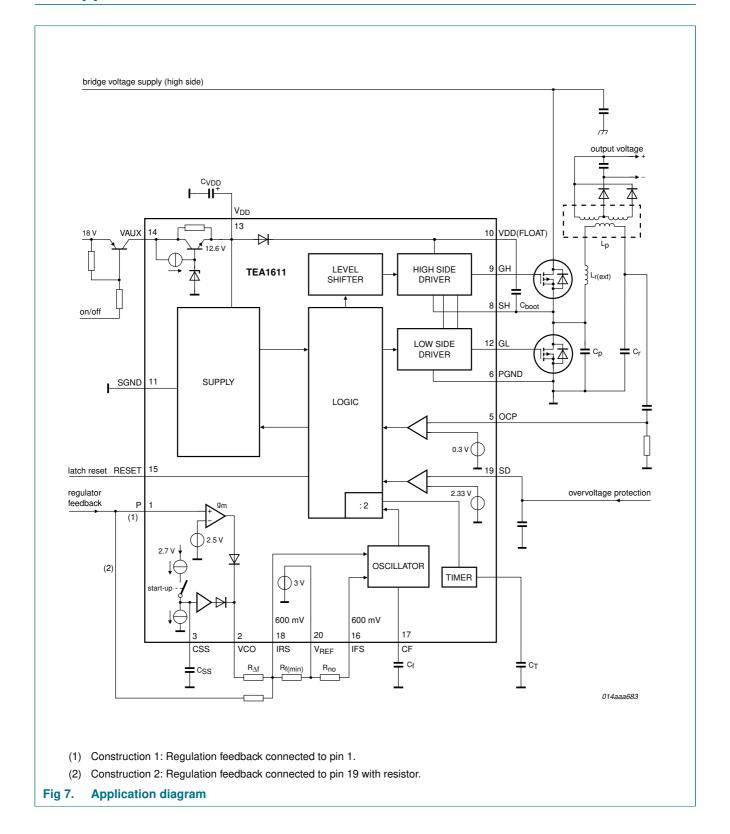
$$\Delta I_{DD} = 2 \times Q_{G(tot)} \times f_{bridge} = 2 \times 55 nC \times 150 kHz = 16.5 mA$$

low side on; high side off; C_f = 100 pF; I_{IFS} = 0.5 mA; I_{IRS} = 50 μ A; low side off; high side off; V_{DD} = 9 V

[2] The frequency of the oscillator depends on the value of capacitor C_f , the peak-to-peak voltage swing V_{CF} and the charge/discharge currents $I_{CF(ch)}$ and $I_{CF(dis)}$.

Zero voltage switching resonant converter controller

11. Application information



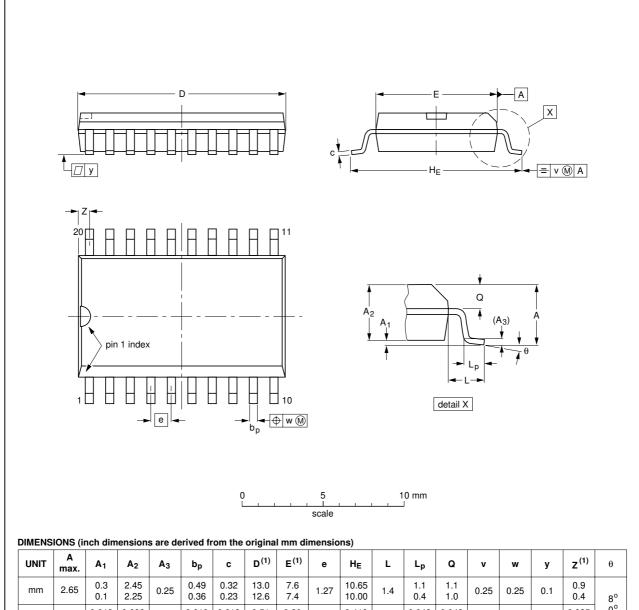
TEA1611T NXP Semiconductors

Zero voltage switching resonant converter controller

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	V	w	у	z ⁽¹⁾	θ
mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013			99-12-27 03-02-19	

Package outline SOT163-1 (SO20) Fig 8.

TEA1611T_1 © NXP B.V. 2009. All rights reserved.

Zero voltage switching resonant converter controller

13. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TEA1611T_1	20090907	Product data sheet	-	-

Zero voltage switching resonant converter controller

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

14.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

14.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

14.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

17 of 18

15. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

TEA1611T_1 © NXP B.V. 2009. All rights reserved.

TEA1611T NXP Semiconductors

Zero voltage switching resonant converter controller

16. Contents

1	General description	ı
2	Features	ĺ
3	Applications	2
4	Ordering information	2
5	Block diagram 3	3
6	Pinning information4	1
6.1	Pinning	1
6.2	Pin description	1
7	Functional description 5	5
7.1	Start-up5	5
7.2	Oscillator 5	5
7.3	Non-overlap time resistor 6	3
7.4	Minimum frequency resistor 6	_
7.5	Maximum frequency resistor	
7.6	Error amplifier	
7.7	Soft start	_
7.8	Overcurrent protection and timer	
7.9	Shut-down	-
7.10	OverTemperature Protection (OTP)	
7.11 7.12	Latch reset input	-
	VAUX input	-
8	Limiting values	
9	Thermal characteristics	
10	Characteristics10	
11	Application information14	1
12	Package outline 15	5
13	Revision history	õ
14	Legal information	7
14.1	Data sheet status	7
14.2	Definitions	7
14.3	Disclaimers	7
14.4	Trademarks17	7
15	Contact information	7
16	Contents	2

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



© NXP B.V. 2009.

All rights reserved.